



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Customer Number: 20277

Ryosuke USUI, et al.

Confirmation Number: 3812

Serial No.: 10/813,629

Group Art Unit: 2811

Filed: March 31, 2004

Examiner:

For:

SEMICONDUCTOR MODULE AND METHOD OF MANUFACTURING THE SAME

## **CORRECTED CLAIM OF PRIORITY**

Mail Stop CPD Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 35 U.S.C. 119, Applicants hereby claim the priority of:

Japanese Patent Application No. 2004-086770, filed March 24, 2004.

Japanese Patent Application No. 2004-065243, filed on March 9, 2004.

Japanese Patent Application No. 2003-093324, filed on March 31, 2003.

cited in the Declaration of the present application.

Respectfully submitted,

MCDERMOTT WILL & EMERY LLP

Registration'No. 26,106

600 13<sup>th</sup> Street, N.W. Washington, DC 20005-3096 202.756.8000 AJS:gav

Facsimile: 202.756.8087

Date: August 16, 2004